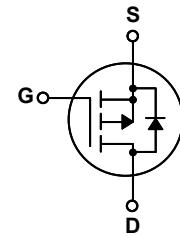


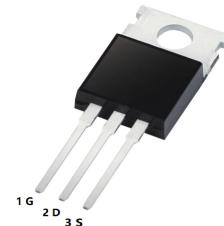
## Description

These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.



## Features

- $V_{DS}$  (V) = -60V
- $I_D$  = -13.5A ( $V_{GS}$  = -10V)
- $R_{DS(ON)}$  < 70mΩ ( $V_{GS}$  = -10V)



## Absolute Maximum Ratings

$T_C$  = 25°C unless otherwise noted

Symbol	Parameter		FQP27P06	Unit	
$V_{DSS}$	Drain-Source Voltage		-60	V	
$I_D$	Drain Current	- Continuous ( $T_C$ = 25°C)	-27	A	
		- Continuous ( $T_C$ = 100°C)	-19.1	A	
$I_{DM}$	Drain Current	- Pulsed (Note 1)	-108	A	
$V_{GSS}$	Gate-Source Voltage		± 25	V	
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)		560	mJ	
$I_{AR}$	Avalanche Current (Note 1)		-27	A	
$E_{AR}$	Repetitive Avalanche Energy (Note 1)		12	mJ	
$dv/dt$	Peak Diode Recovery $dv/dt$ (Note 3)		-7.0	V/ns	
$P_D$	Power Dissipation ( $T_C$ = 25°C) - Derate above 25°C		120	W	
			0.8	W/°C	
$T_J, T_{STG}$	Operating and Storage Temperature Range		-55 to +175	°C	
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

## Thermal Characteristics

Symbol	Parameter	FQP27P06	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.25	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

## Elerical Characteristics

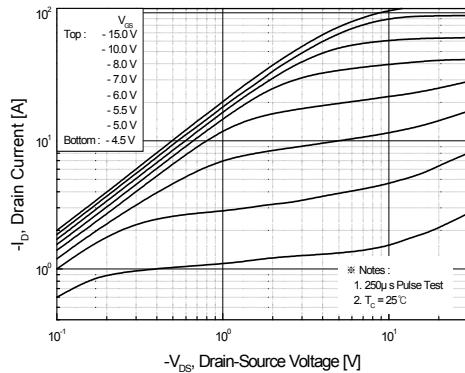
 $T_C = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-60			V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$		-0.06		$^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$		-1		$\mu\text{A}$
		$V_{DS} = -48 \text{ V}, T_C = 150^\circ\text{C}$		-10		$\mu\text{A}$
$I_{GSSF}$	Gate-Body Leakage Current, Forward	$V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$		-100		nA
$I_{GSSR}$	Gate-Body Leakage Current, Reverse	$V_{GS} = 25 \text{ V}, V_{DS} = 0 \text{ V}$		100		nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	-1.1	-2	-3.0	V
$R_{DS(\text{on})}$	Static Drain-Source On-Resistance	$V_{GS} = -10 \text{ V}, I_D = -13.5 \text{ A}$		55	70	$\text{m}\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = -30 \text{ V}, I_D = -13.5 \text{ A}$		12.4		S
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$		1100	1400	pF
$C_{oss}$	Output Capacitance			510	660	pF
$C_{rss}$	Reverse Transfer Capacitance			120	155	pF
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = -30 \text{ V}, I_D = -13.5 \text{ A}, R_G = 25 \Omega$		18	45	ns
$t_r$	Turn-On Rise Time			185	380	ns
$t_{d(off)}$	Turn-Off Delay Time			30	70	ns
$t_f$	Turn-Off Fall Time		(Note 4)	90	190	ns
$Q_g$	Total Gate Charge	$V_{DS} = -48 \text{ V}, I_D = -27 \text{ A}, V_{GS} = -10 \text{ V}$		33	43	nC
$Q_{gs}$	Gate-Source Charge			6.8		nC
$Q_{gd}$	Gate-Drain Charge		(Note 4)	18		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_S$	Maximum Continuous Drain-Source Diode Forward Current			-27		A
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current			-108		A
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = -27 \text{ A}$		-4.0		V
$t_{rr}$	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_S = -27 \text{ A}, dI_F / dt = 100 \text{ A}/\mu\text{s}$		105		ns
$Q_{rr}$	Reverse Recovery Charge			0.41		$\mu\text{C}$

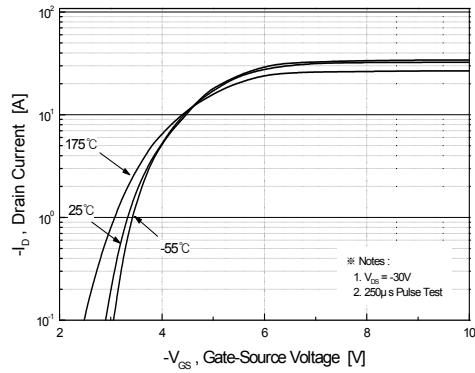
**Notes:**

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2.  $L = 0.9\text{mH}, I_{AS} = -27\text{A}, V_{DD} = -25\text{V}, R_G = 25 \Omega$ , Starting  $T_J = 25^\circ\text{C}$
3.  $I_{SD} \leq -27\text{A}, dI/dt \leq 300\text{A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$
4. Essentially independent of operating temperature

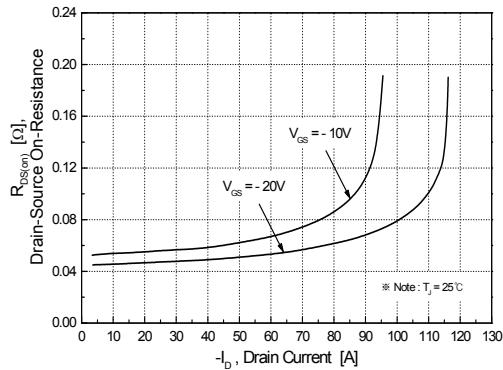
## Typical Characteristics



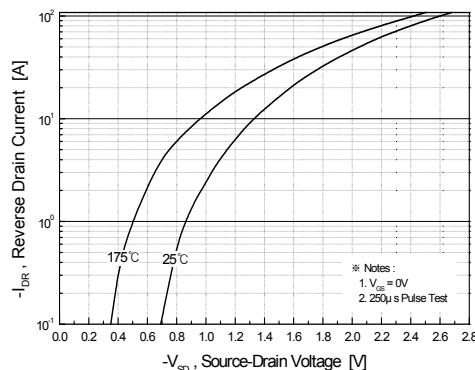
**Figure 1. On-Region Characteristics**



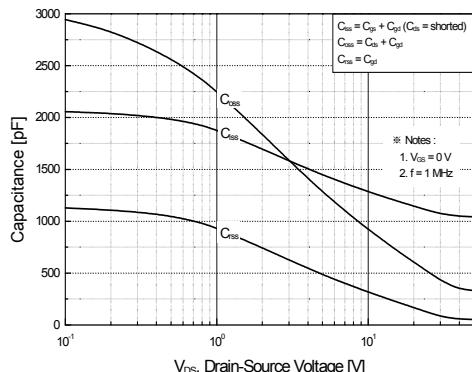
**Figure 2. Transfer Characteristics**



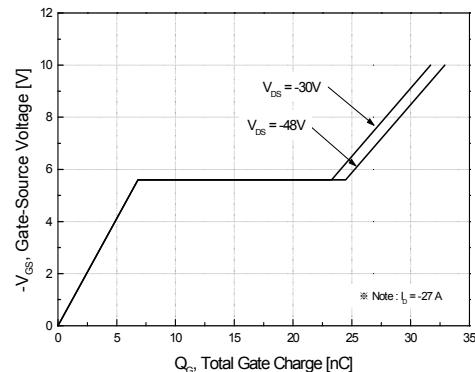
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**

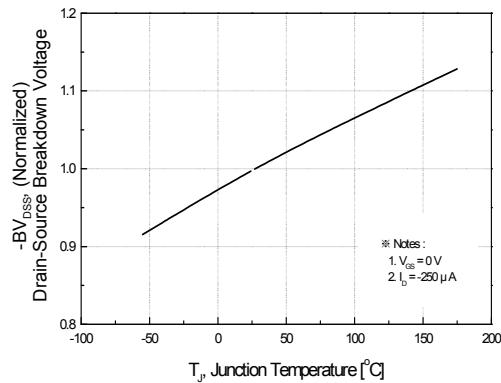


**Figure 5. Capacitance Characteristics**

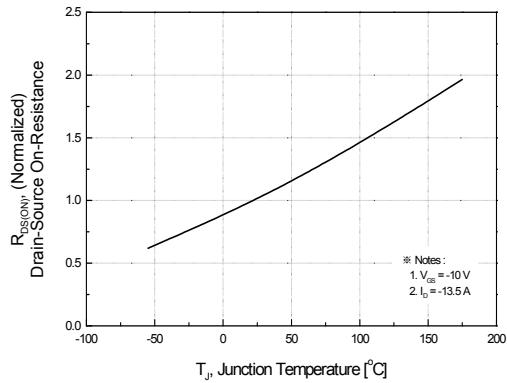


**Figure 6. Gate Charge Characteristics**

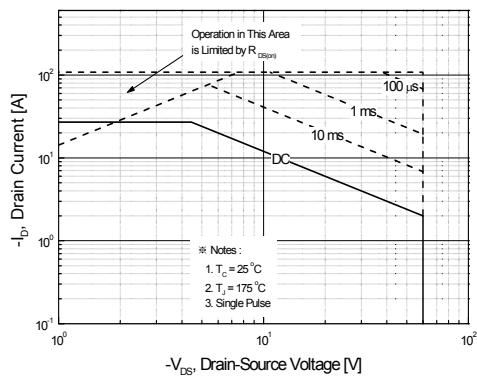
## Typical Characteristics



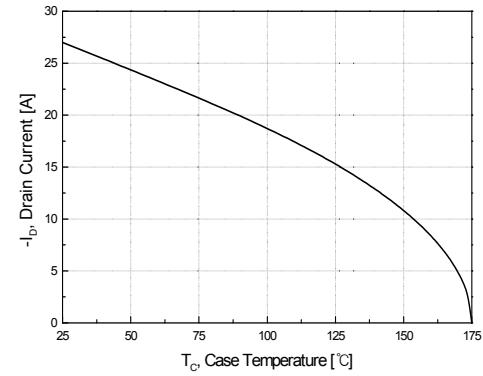
**Figure 7. Breakdown Voltage Variation  
vs. Temperature**



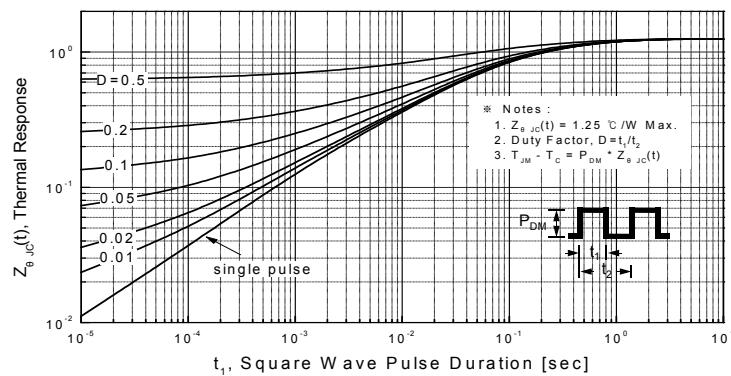
**Figure 8. On-Resistance Variation  
vs. Temperature**



**Figure 9. Maximum Safe Operating Area**

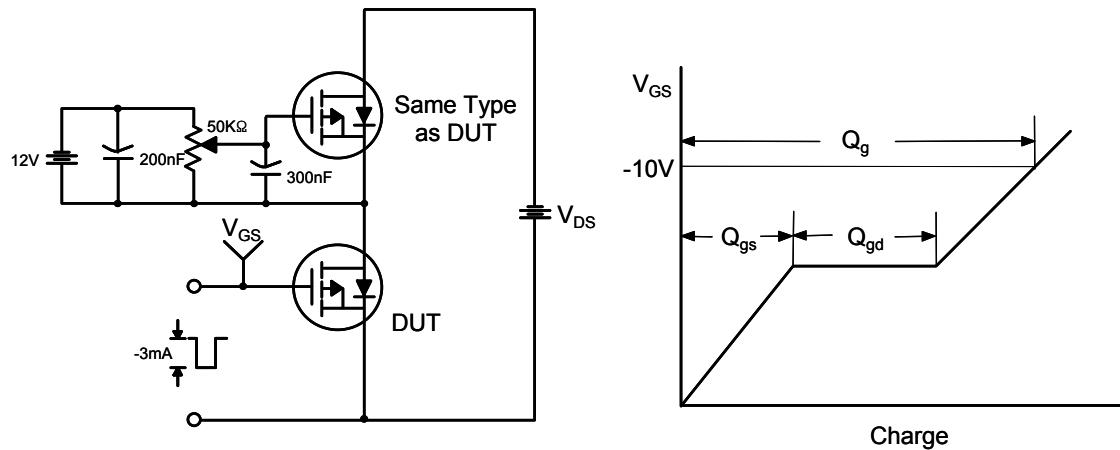


**Figure 10. Maximum Drain Current  
vs. Case Temperature**

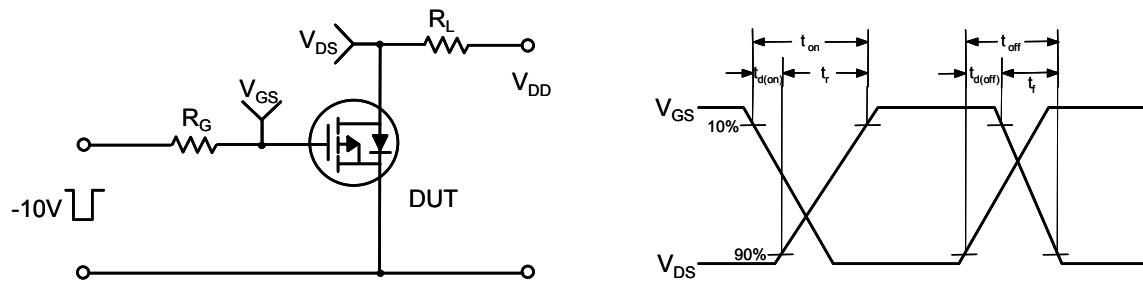


**Figure 11. Transient Thermal Response Curve**

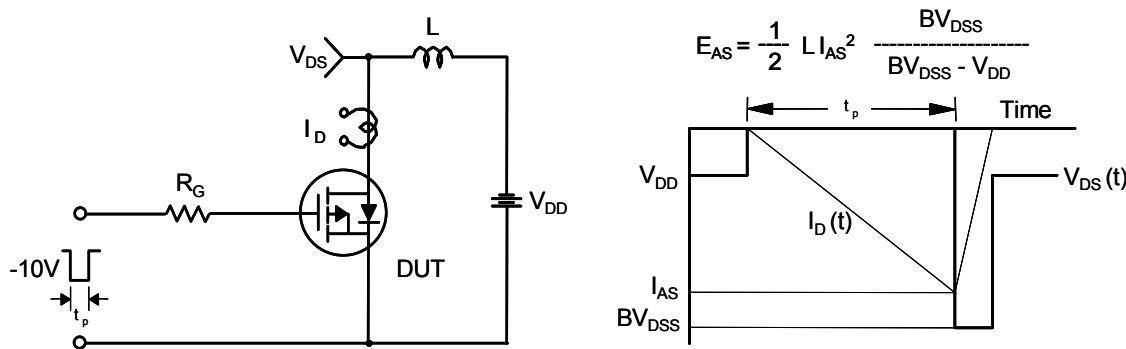
Gate Charge Test Circuit & Waveform



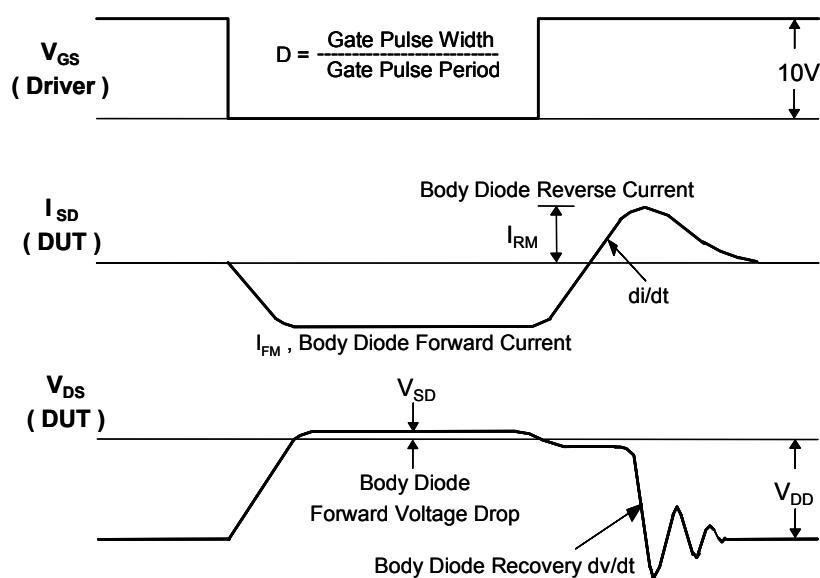
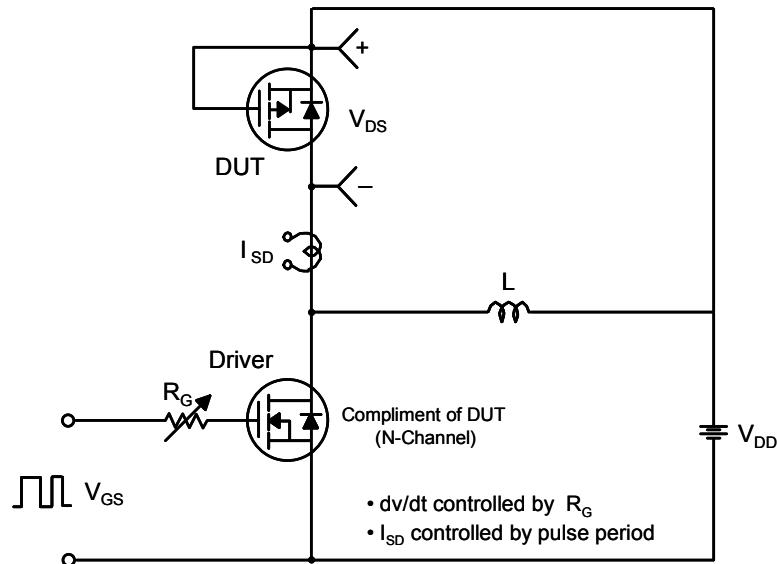
Resistive Switching Test Circuit & Waveforms



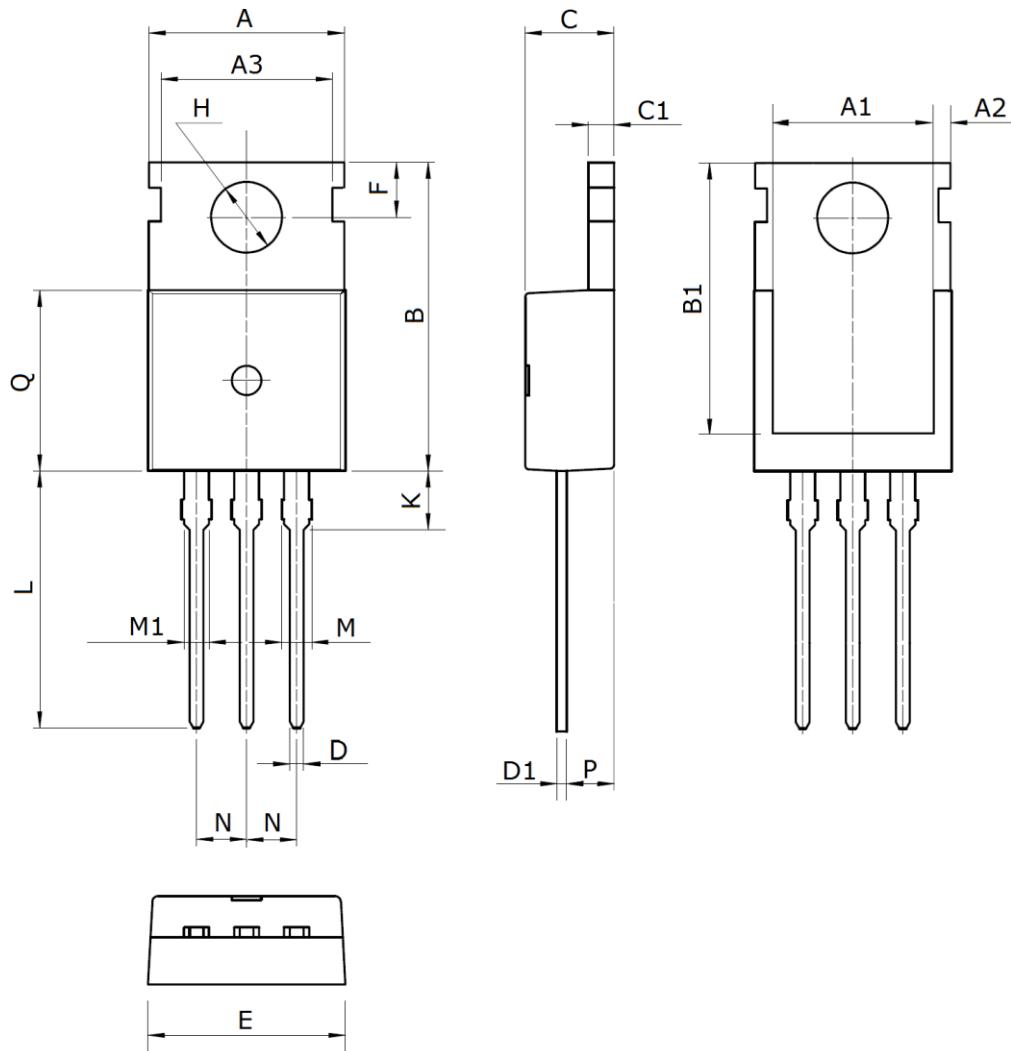
Unclamped Inductive Switching Test Circuit & Waveforms



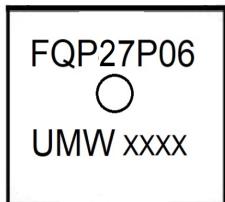
## Peak Diode Recovery dv/dt Test Circuit &amp; Waveforms



## Package Mechanical Data TO-220



Symbol	Dimensions (mm)	Symbol	Dimensions (mm)	Symbol	Dimensions (mm)
A	10.0±0.3	C1	1.3±0.2	L	13.2±0.4
A1	8.0±0.2	D	0.8±0.2	M	1.38±0.1
A2	0.94±0.1	D1	0.5±0.1	M1	1.28±0.1
A3	8.7±0.1	E	10.0±0.3	N	2.54(typ)
B	15.6±0.4	F	2.8 ±0.1	P	2.4±0.3
B1	13.2 ±0.2	H	3.6±0.1	Q	9.15±0.25
C	4.5±0.2	K	3.1±0.2		

**Marking****Ordering information**

Order code	Package	Baseqty	Deliverymode
UMW FQP27P06	TO-220	1000	Tape and reel